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## Reducing Fracture Tendencies in PCBN FSW Tools

ONR Contract Number N00014-09-C-0288

### **Semi Annual Report No. 1**

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## Contract Information

Contract Number	N00014-09-C-0288
Title of Research	Reducing Fracture Tendencies in PCBN FSW Tools
Principal Investigator	David Marshall
Organization	Teledyne Scientific Company

## Technical Section

### *Technical Objectives*

The overall goal of this program is to increase the life of PCBN tools in friction-stir welding of high temperature metals. This will be achieved through the following objectives:

- (1) Understand the fundamental causes for limited lifetimes of PCBN tools during Friction-Stir Welding (FSW) of high temperature metals, including both wear and fracture.
- (2) Identify microstructural characteristics and defects in PCBN materials that affect lifetime in FSW.
- (3) Identify and develop simple mechanical/fracture test methods that can be used on PCBN materials as indicators of potential lifetime in FSW.
- (4) Use information gained in (1) to (3) to guide development of new grades of PCBN or modifications to existing grades or tool design to improve lifetime during FSW.

### *Technical Approach*

We have formed a multidisciplinary team to tackle the problem of increasing the life of PCBN tools in FSW of high temperature metals. Studies in this program at Teledyne Scientific are being coordinated with complementary, collaborative studies on manufacturing improved grades of PCBN at Megadiamond, tool manufacture at Advanced Metal Products, and other ONR supported FSW studies at Brigham Young University.

Two routes are being followed by the team to improve tool life. One involves development of improved PCBN materials with increased resistance to damage. The other involves improvement of tool designs and control of FSW operating parameters to minimize detrimental loads on the tool during welding. Progress along both of these routes is currently impeded by gaps in our understanding of how damage (fracture and wear) develops in the tools during FSW, knowledge of the microstructural features or defects within the PCBN material that control the resistance to damage, and the capability to measure the relevant material properties that characterize the resistance to damage. The following studies are being undertaken in this program to fill these gaps:

- (i) Identification of modes of failure and life-limiting damage during FSW by analysis of crack patterns in tools after being used in friction stir experiments, including: sectioning partly cracked tools to allow observation of fracture surfaces and to determine sub-surface crack shapes; monitoring crack development in interrupted tests; correlation of observed crack geometry with known thermal and mechanical stresses; and development of analytical fracture models to aid in distinguishing characteristics of stress distributions (static and cyclic) capable of giving the observed cracking behavior.
- (ii) development of methods based on indentation fracture to measure fracture toughness, resistance to fatigue cracking, and resistance to thermal shock of PCBN materials, and to assess wear properties.



Conventional fracture mechanics methods based on large test specimens are impractical with these materials because they are only manufactured in small sizes ( $< 1 \text{ in}^3$ ), are extremely costly, and are extremely difficult to machine into test specimens.

(iii) Using a set of materials that show large differences in wear and cracking behavior during FSW, measure fracture properties, microstructural characteristics, and other relevant properties; then correlate these properties with FSW performance. These results will allow us to infer the influences of microstructure on toughness and other properties and thence on tool performance, as well as predict directions for modifying processing to improve tool life.

### ***Progress Statement Summary***

At a kick-off meeting held in February 2009, several materials and tools were selected for initial studies:

*1. Understanding Fracture Causes and Mechanisms in PCBN:* six FSW tools with varying degrees of damage from FSW experiments were supplied by C. Sorensen and M. Mahoney at BYU. After initial examination of these tools, plans have been made for removing some of the tool material inserts from the tool holders for sectioning and fractography, with the aim of determining the site of crack initiation. Some of the tools will be subjected to a further FSW run, after infiltrating existing cracks with a material that will act as a high temperature dye penetrant. They will then be sectioned and/or fractured to determine the incremental crack growth during the FSW run. Experiments are under way to optimize and assess the relative effectiveness of several metal acetate solutions that have the potential to serve as dye penetrants in defining the crack shape.

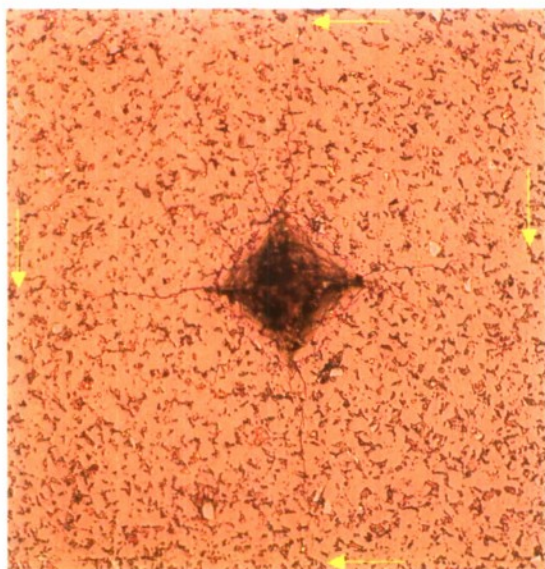
*2. Identification of relations between tool life, microstructure, and toughness measurements.* Initial experiments have focused on materials from three lots of MS80 PCBN materials that showed large differences in properties. All consist of 80% BN, with the remainder mainly AlN, although the methods of powder mixing during processing differed. Two of these were used in FSW experiments and showed different susceptibility to cracking: one survived 206 plunges (#1298), whereas the other survived only two plunges (#1307). The third material, from a recent production run with modified heat treatment conditions, was found to be much more difficult to grind than the other two materials. We have developed modified methods for polishing these three materials and demonstrated that cracking by indentation with a Vickers indenter can be used to obtain valid fracture toughness measurements. These measurements indicated that the fracture toughness of the new material that is difficult to machine was significantly higher than the toughnesses of the other two materials. Microstructural analysis by scanning electron microscopy and Raman microprobe spectroscopy revealed that, surprisingly, the new material contained a significant amount of well dispersed diamond. The diamond particles are not expected to influence the indentation toughness measurements, although they clearly have an influence on the grinding and polishing behavior (and hence on tool wear). In the course of SEM examination of these and other materials we discovered (in collaboration with Megadiamond) an imaging method that reveals internal deformation structures in BN grains, which are not normally detectable by SEM. The method is useful for assessing damage caused by grain-to-grain contact during high pressure consolidation.

### ***Progress***

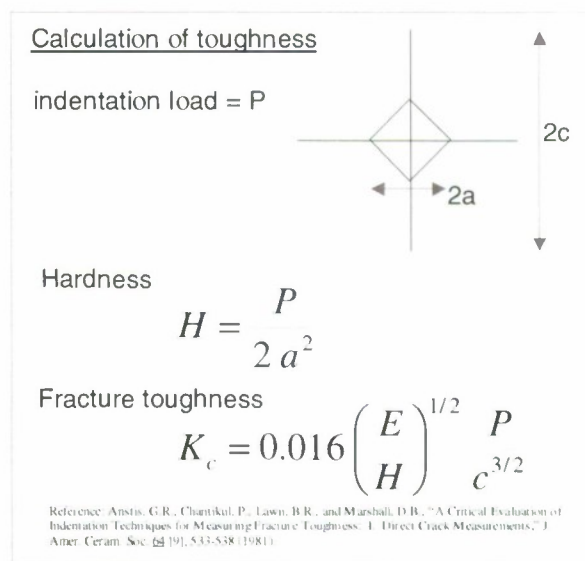
#### ***Fracture toughness measurement***

The fracture toughnesses of the three MS80 materials described above were measured by indentation fracture. The method, which is summarized in Fig. 1, involves loading a Vickers diamond indenter on a

polished surface, generating a contact zone of plastic deformation (from which the hardness can be evaluated) and two half-penny cracks centered on the indentation and aligned normal to the surface along the indentation diagonals. A fracture mechanics analysis of the formation of these cracks gives the expression in Fig. 1b, which is valid if the cracks are sufficiently large compared with the contact zone. This expression can be used to evaluate the fracture toughness from the measured crack lengths.



(a)



(b)

Fig. 1. Indentation method for measurement of fracture toughness: (a) Vickers indentation (200N load) in polished surface of polycrystalline cubic BN (MS80). Arrows indicate positions of crack tips, which can be readily located in higher magnification optical micrographs; (b) Schematic of indentation and cracks, with fracture mechanics expression from which the fracture toughness can be evaluated.

This technique has been developed extensively with ceramic materials, although it has not been applied previously to PCBN materials. Indentations in PCBN at loads smaller than ~50 N generally produce irregular crack patterns because of their high hardness and relatively large grain size. However, at higher loads well developed cracks are produced, as in Fig. 1.

One of the challenges in applying the method to these materials was in developing a method for locating the positions of the crack tips reliably. Initially, using surfaces that were not well polished, we found that optical microscopy was inadequate and high resolution electron microscopy was necessary, making the method extremely laborious. However, after developing an improved polishing method, we found that the crack tips could be located reliably using high magnification optical microscopy.

The results of toughness measurements from the three MS80 materials are summarized in Fig. 2. Also shown are measurements from another PCBN material (MN100) which has much higher volume fraction of BN and smaller amount of grain boundary phase (AlN). For each material the toughness was evaluated from indentations at several different loads within the range 50 to 200 N, with each data point being an average of at least 10 measurements. The observation in Fig. 2 that, in all cases, the toughness is

independent of the indentation load confirms the functional form of the toughness equation and thus the validity of the underlying fracture mechanics analysis.

Significant differences are evident in the fracture toughnesses of the three MS80 materials. The highest toughness ( $5.2 \text{ MPa}\cdot\text{m}^{1/2}$ ) is observed in the new material which was also much more difficult to grind and polish than the other two materials. However, the relative ranking for the other two materials is opposite to their relative performance in FSW: the material with lower toughness (#1298) is the one with the longer FSW life. Further measurements will be made to investigate whether this trend is followed in other materials.

The hardness of these materials is expected to scale with the volume fraction of BN and be relatively insensitive to subtle microstructural variations that influence fracture toughness. The measured hardnesses listed in Fig. 2 are consistent with this expectation: the values for the three MS80 materials are indistinguishable (30 GPa) whereas the value for the MN100 material is higher (34 GPa).

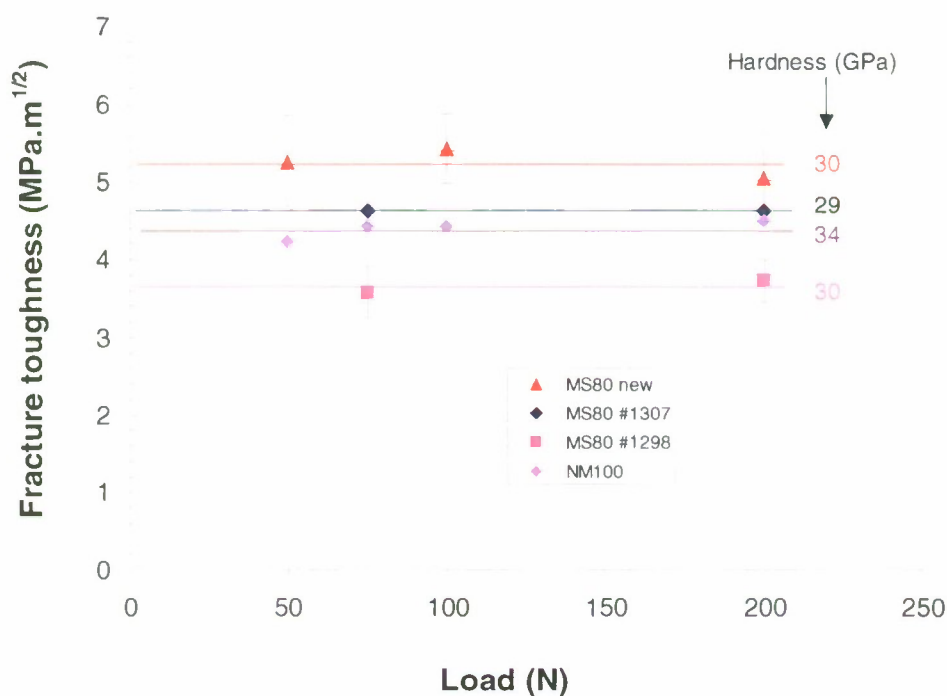


Fig. 2. Indentation fracture toughness measurements from several PCBN materials. Error bars indicate standard deviations.

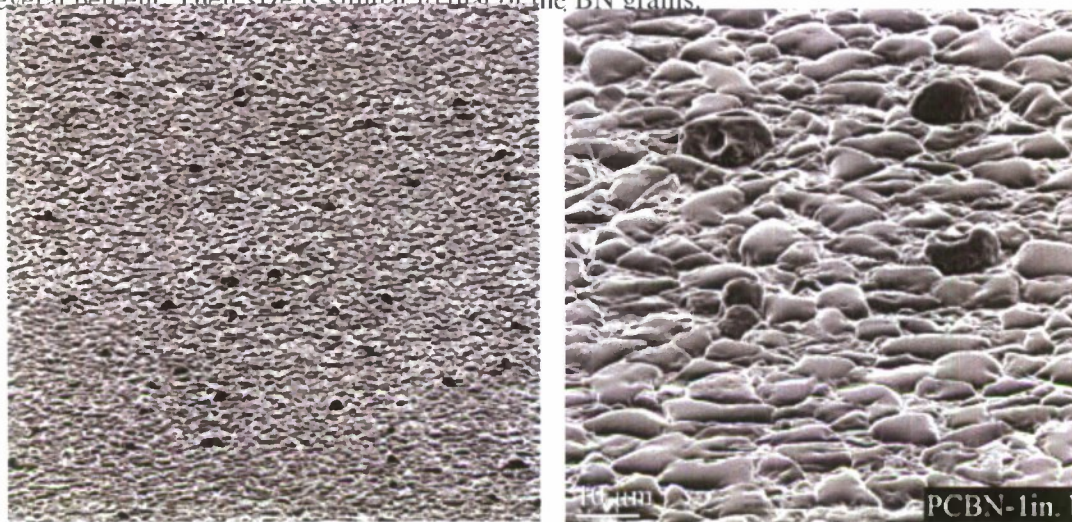
### Microstructural Analysis

#### Identification of diamond particles in new MS80 material

The new MS80 material was much more difficult to cut and polish than other PCBN materials. After initial attempts to polish the surface of this material using a relatively soft cloth that produced a good polish on other PCBN materials, we found that strong relief was produced, with some grains remaining raised significantly above the majority of grains (Fig. 3). EDS analysis indicated that these grains were

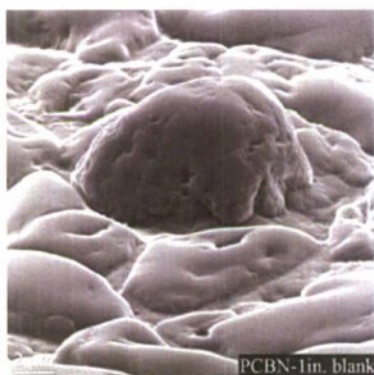


carbon. Analysis by Raman microprobe spectroscopy confirmed that the grains are diamond. The diamond grains were distributed very uniformly throughout the material, with a volume fraction of several percent. Their size is similar to that of the BN grains.



(a)

(b)



(c)

*Fig. 3 SEM micrographs of new MS80 material showing surface after polishing with diamond impregnated cloth which produced relief of diamond particles (same area at three different magnifications). Dark grains in (a) are diamond*

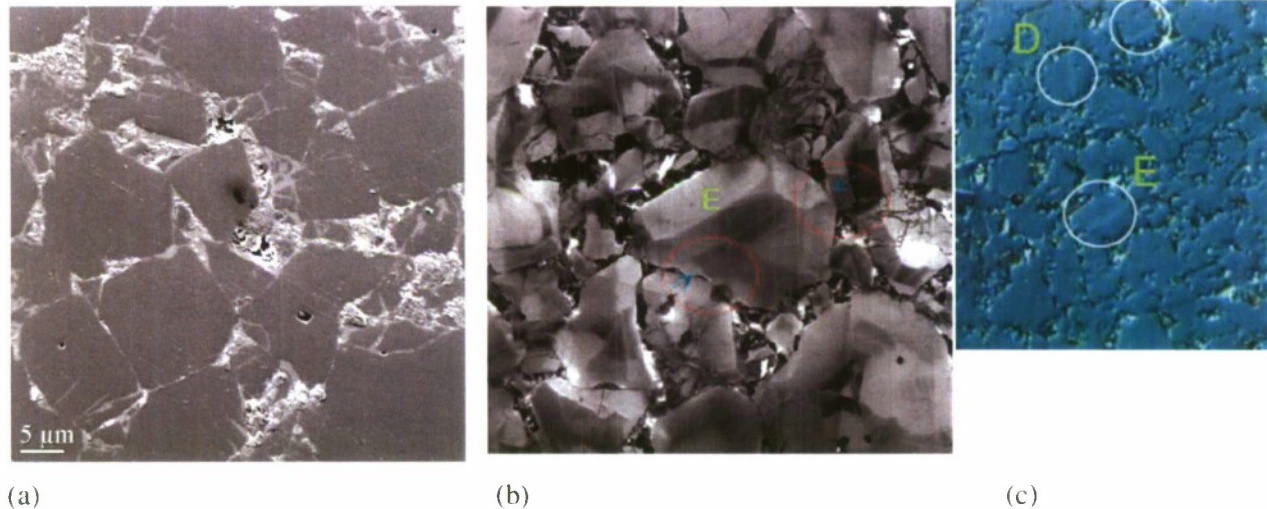
The spacing of the diamond grains is sufficiently large that very few were intersected by the indentation cracks used to measure the fracture toughness. Therefore, we do not expect the presence of the diamond grains to affect the fracture toughness. Similarly, the volume fraction of diamond is sufficiently small that a significant effect on hardness is not expected, consistent with the measurements summarized in Fig. 2. However, the presence of diamond grains may be expected to play a key role in increasing the resistance to grinding and polishing, as well as tool wear.

#### *Imaging of internal deformation structures in BN grains*

In the course of SEM examination of these materials we discovered (in collaboration with Megadiamond) an imaging method that reveals internal crystallographic structures in BN grains, which are not normally detectable by SEM. An example is shown in Fig 4. When imaged with secondary electrons, with a thin conducting layer of gold deposited on the surface to prevent charging (the usual procedure for insulating materials), the BN grains are featureless and the AlN grain boundary phase shows lighter contrast (Fig.

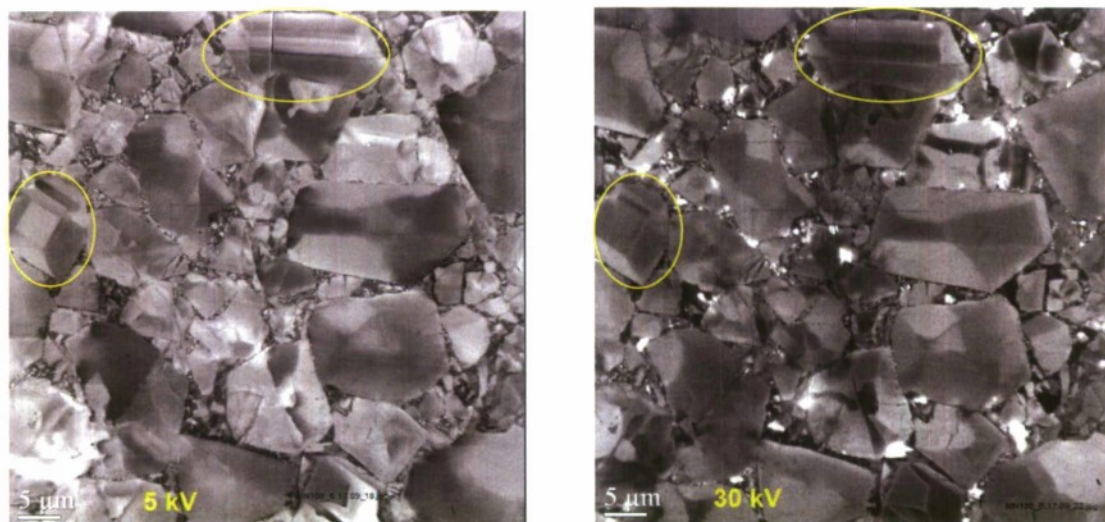


4a). Similar contrast is seen in backscattered electron images (Fig. 5). However, when imaged with secondary electrons without a conducting layer on the surface, dramatically different contrast is observed (Fig. 4b): crystallographic features resembling twins are clearly evident, more contrast detail is visible within the grain boundary phases, and there is a general reversal of contrast between the grains and the grain boundary phase (the BN grains being lighter than the grain boundary phase). In many grains, there is a one-to-one correspondence between these crystallographic features and lines of surface relief visible by Nomarski interference (Fig. 4c). The surface relief may result from different polishing rates in regions of different crystallographic orientations.



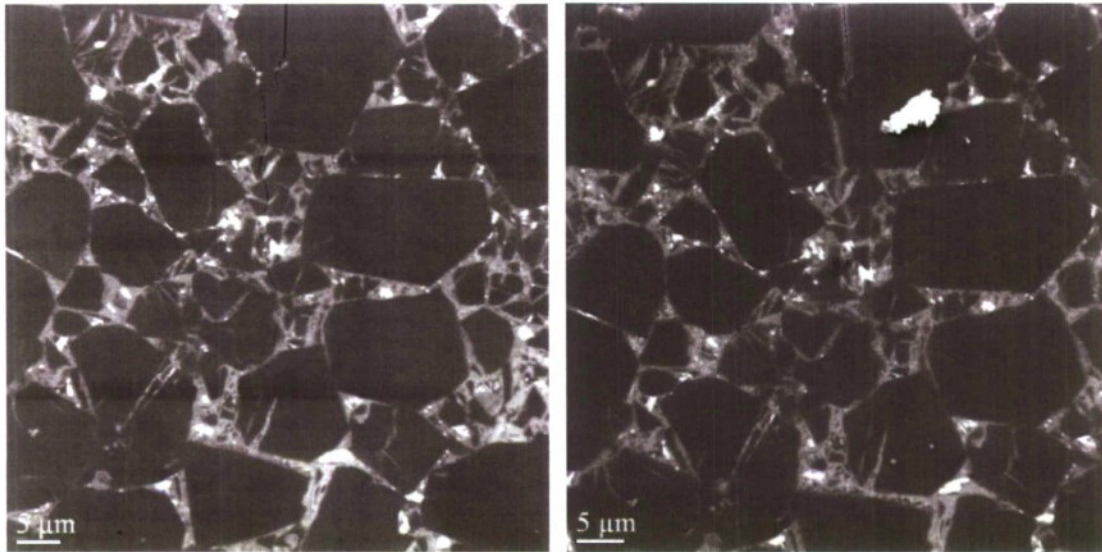
*Fig. 4. Polished surface of MN100 material: (a) SEM image from surface coated with conducting layer of gold; (b) SEM image from uncoated surface (micrograph from Qingyuan Liu, Megadiamond); (c) Nomarski interference micrograph from area in (b), showing surface relief features in some grains.*

The detailed contrast in images such as Fig. 4b was found to be sensitive to the accelerating voltage, with reversals of contrast occurring within some grains when the voltage was changed (Fig. 5). This and the observation that the contrast within the BN grains disappears when surface is coated with conducting gold suggests that contrast may be associated with charging. (The image contrast also disappears when the surface is coated with carbon, Fig. 6, thus eliminating the possibility that the contrast is obscured by scattered electrons from the gold coating.)





*Fig. 5. Reversal of contrast in secondary electron images from uncoated surface of MN100 material at two different accelerating voltages: (a) 5 KV; (b) 30 KV.*



*Fig. 6. Images from area of Fig. 5: (a) backscattered electron image, uncoated surface; (b) secondary electron image after coating the surface with carbon.*

We hypothesize that these contrast features may correspond to internal twins or other deformation structures in BN grains, possibly caused local contact forces due to grain-to-grain contact during high pressure consolidation. Similar contrast features are observed in the MS80 materials, although only a small fraction of grains show internal features (consistent with expectation that, with the higher binder content, less damage occurs in MS80 from neighboring grains being in direct contact during densification).